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FGP5N60LS

600 V, 5 A Field Stop IGBT



# FGP5N60LS 600 V, 5 A Field Stop IGBT

#### **Features**

- · High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)} = 1.7 \text{ V} @ I_C = 5 \text{ A}$
- High Input Impedance
- RoHS Compliant

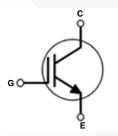
### **Applications**

HID Ballast

### **General Description**

Using novel field stop IGBT technology, Fairchild's new series of field stop IGBTs offer the optimum performance for HID ballast where low conduction losses are essential.





### **Absolute Maximum Ratings**

Symbol	Description  Collector to Emitter Voltage		Ratings	Unit V	
V <sub>CES</sub>			600		
V <sub>GES</sub>	Gate to Emitter Voltage		±20	V	
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 25°C	10	А	
.0	Collector Current	$@ T_C = 100^{\circ}C$	5	А	
I <sub>CM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	36	A	
P <sub>D</sub>	Maximum Power Dissipation	$@ T_C = 25^{\circ}C$	83	W	
טי	Maximum Power Dissipation	$@ T_C = 100^{\circ}C$	33	W	
T <sub>J</sub>	Operating Junction Temperature		-55 to +150	°C	
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C	
T <sub>L</sub>	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes: 1: Repetitive test , Pulse width = 100 usec , Duty = 0.2,  $V_{GE}$  = 13.5 V

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	-	1.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		62.5	°C/W

# **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGP5N60LS	FGP5N60LS	TO-220	Tube	N/A	N/A	50

# Electrical Characteristics of the IGBT $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	600	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	-	0.8	-	V/°C
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μА
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_C = 250 \mu A, V_{CE} = V_{GE}$	2.7	3.9	4.5	V
		I <sub>C</sub> = 5 A, V <sub>GE</sub> = 15 V	-	1.7	2.1	٧
V	Collector to Emitter Saturation Voltage	$I_C = 5 \text{ A}, V_{GE} = 15 \text{ V},$ $T_C = 125^{\circ}\text{C}$	-	1.8	-	V
V <sub>CE(sat)</sub>		I <sub>C</sub> = 14 A, V <sub>GE</sub> = 12 V	-	2.7	3.2	٧
	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 14 A, V <sub>GE</sub> = 12 V, T <sub>C</sub> = 125°C	-	3.1	-	V
Dynamic C	haracteristics					
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V,	-	278	-	pF
C <sub>oes</sub>	Output Capacitance		-	28	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance	-1 = 1 1011112	-	11	-	pF
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time		-	4.3	-	ns
t <sub>r</sub>	Rise Time		-	1.6	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 5 \text{ A},$	-	36	-	ns
t <sub>f</sub>	Fall Time	$R_G = 10 \Omega$ , $V_{GE} = 15 V$ ,	-	118	-	ns
E <sub>on</sub>	Turn-On Switching Loss	Inductive Load, T <sub>C</sub> = 25°C	-	38	- /	μJ
E <sub>off</sub>	Turn-Off Switching Loss		-	130	-	μJ
E <sub>ts</sub>	Total Switching Loss		-	168	-	μJ
t <sub>d(on)</sub>	Turn-On Delay Time		-	4.1	-	ns
t <sub>r</sub>	Rise Time		-	1.8	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 5 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ Inductive Load, $T_{C} = 125^{\circ}\text{C}$	-	37	- [	ns
t <sub>f</sub>	Fall Time		-	150	- \	ns
E <sub>on</sub>	Turn-On Switching Loss		-	80	-	μJ
E <sub>off</sub>	Turn-Off Switching Loss		-	168	-	μJ
E <sub>ts</sub>	Total Switching Loss		-	248	-	μJ
Q <sub>g</sub>	Total Gate Charge		-	18.3	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge	$V_{CE} = 400 \text{ V}, I_{C} = 5 \text{ A},$	-	1.6	-	nC
Q <sub>gc</sub>	Gate to Collector Charge	V <sub>GE</sub> = 15 V	-	7.9	-	nC

**Figure 1. Typical Output Characteristics** 

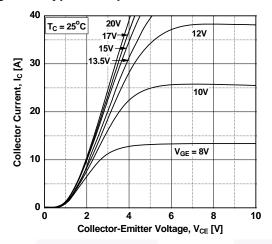


Figure 3. Typical Saturation Voltage Characteristics

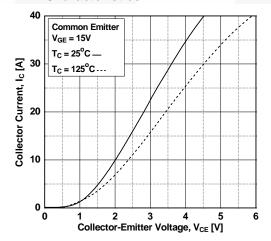


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level

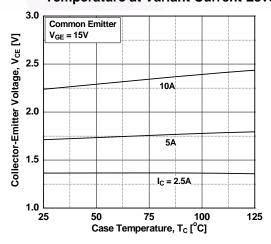
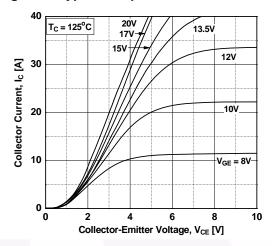


Figure 2. Typical Output Characteristics



**Figure 4. Transfer Characteristics** 

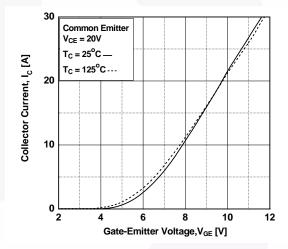


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

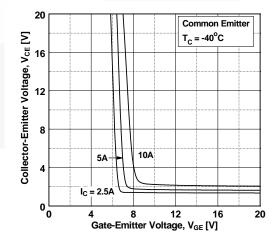


Figure 7. Saturation Voltage vs. V<sub>GE</sub>

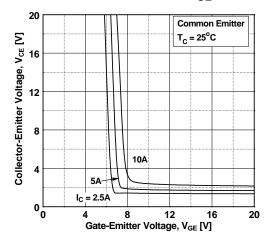


Figure 9. Capacitance Characteristics

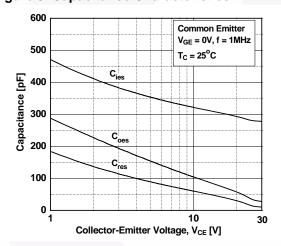


Figure 11. SOA Characteristics

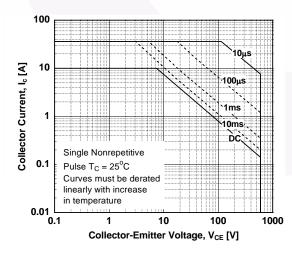


Figure 8. Saturation Voltage vs. V<sub>GE</sub>

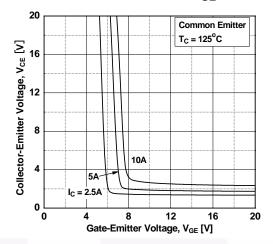


Figure 10. Gate charge Characteristics

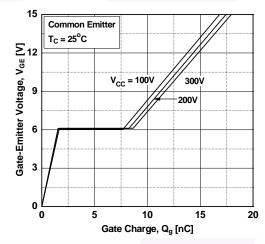


Figure 12. Turn-on Characteristics vs.
Gate Resistance

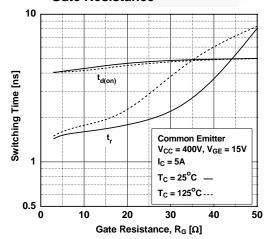


Figure 13. Turn-off Characteristics vs.
Gate Resistance

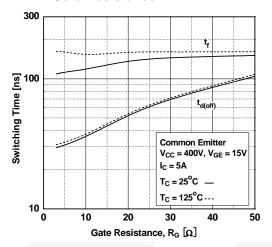


Figure 15. Turn-off Characteristics vs. Collector Current

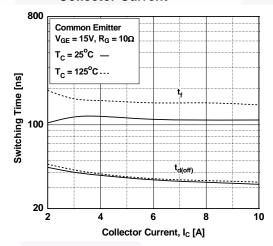


Figure 17. Switching Loss vs. Collector Current

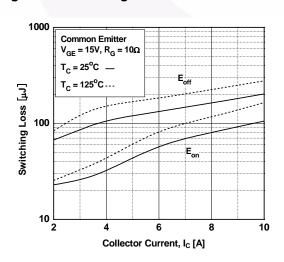


Figure 14. Turn-on Characteristics vs. Collector Current

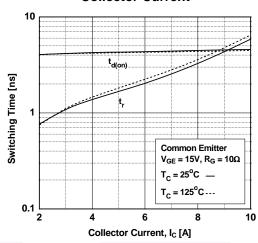


Figure 16. Switching Loss vs. Gate Resistance

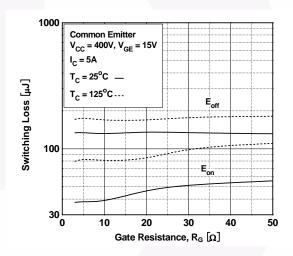


Figure 18. Turn off Switching SOA Characteristics

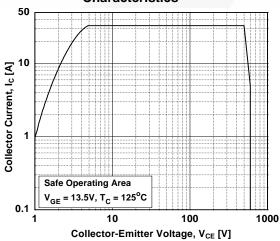
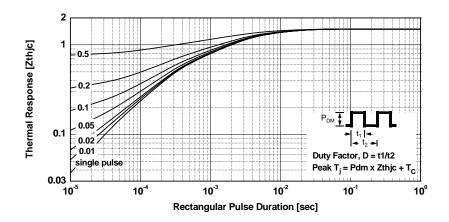


Figure 19.Transient Thermal Impedance of IGBT



#### **Mechanical Dimensions**

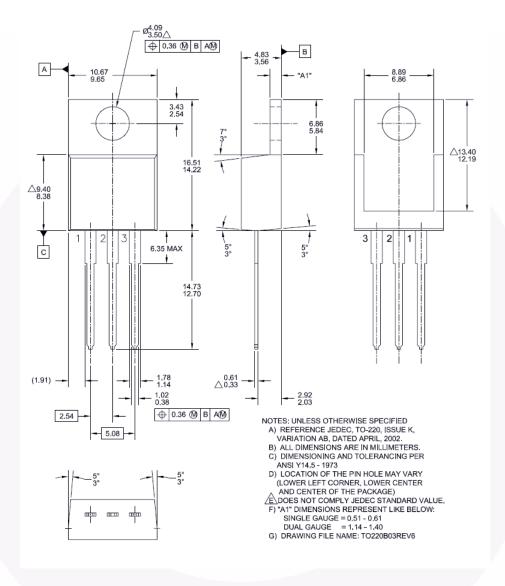


Figure 20. TO-220 3L - TO-220, MOLDED, 3LEAD, JEDEC VARIATION AB

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